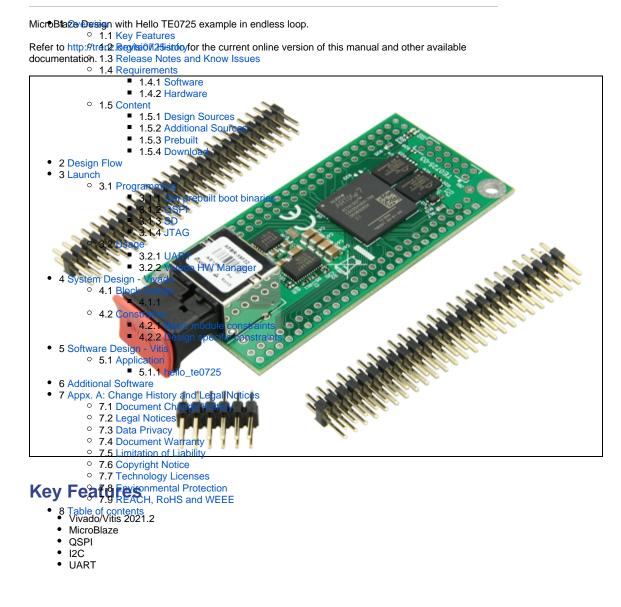
TE0725 Test Board

Tobler of contents



Revision History

Date	Vivado	Project Built	Authors	Description
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2022-08-29	2021.2	TE0725- test_board_noprebui lt-vivado_2021.2- build_15_20220829 124226.zip TE0725-test_board- vivado_2021.2- build_15_20220829 124226.zip	Waldemar Hanemann	 2021.2 update Documentation style update
2020-04-20	2019.2	TE0725- test_board_noprebui lt-vivado_2019.2- build_10_20200420 092827.zip TE0725-test_board- vivado_2019.2- build_10_20200420 092815.zip	John Hartfiel	• 2019.2 update
2018-08-09	2018.2	TE0725- test_board_noprebui lt-vivado_2018.2- build_02_20180809 122533.zip TE0725-test_board- vivado_2018.2- build_02_20180809 122018.zip	John Hartfiel	• 2018.2 update
2018-03-18	2017.4	TE0725- test_board_noprebui lt-vivado_2017.4- build_07_20180319 171220.zip TE0725-test_board- vivado_2017.4- build_07_20180319 171209.zip	John Hartfiel	 Board Part update reference link only
2018-03-16	2017.4	TE0725- test_board_noprebui lt-vivado_2017.4- build_07_20180316 163402.zip TE0725-test_board- vivado_2017.4- build_07_20180316 163351.zip	John Hartfiel	• initial release

Design Revision History

Release Notes and Know Issues

Issues	Description	Workaround	To be fixed version
No known issues			

Known Issues

Requirements

Software

Software	Versio	n Note
Vitis	2021.2	needed, Vivado is included into Vitis installation

Software

Hardware

Basic description of TE Board Part Files is available on TE Board Part Files.

Complete List is available on <design name>/board_files/*_board_files.csv

Design supports following modules:

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	ЕММС	Others	Notes
TE0725-03- 15-1C	15_1c	REV03 REV0 2 REV01	NA	32MB	NA	8MB HypeRAM	NA
TE0725-03- 35-2C	35_2c	REV03 REV0 2 REV01	NA	32MB	NA	8MB HypeRAM	NA
TE0725-03- 100-2C	100_2c	REV03 REV0 2 REV01	NA	32MB	NA	8MB HypeRAM	NA
TE0725-03- 100-2CF	100_2c	REV03 REV0 2 REV01	NA	32MB	NA	8MB HypeRAM	POF assembled
TE0725-03- 100-2l9	100_2i	REV03 REV0 2 REV01	NA	32MB	NA	8MB HypeRAM	NA
TE0725-03- 35-2I	35_2i	REV03 REV0 2 REV01	NA	32MB	NA	8MB HypeRAM	NA

Hardware Modules

Design supports following carriers:

Carrier Model	Notes

*used as reference

Hardware Carrier

Additional HW Requirements:

Additional Hardware	Notes
TE0790 JTAG Programmer	It's not recommended to use TE0790 for power supply(TE0790 TRM#PowerandPower- OnSequence)
External power supply	

*used as reference Additional Hardware

Content

For general structure and of the reference design, see Project Delivery - AMD devices

Design Sources

Туре	Location	Notes
Vivado	<project folder="">\block_design <project folder="">\constraints <project folder="">\ip_lib <project folder="">\board_files</project></project></project></project>	Vivado Project will be generated by TE Scripts
Vitis	<project folder="">\sw_lib</project>	Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation

Design sources

Additional Sources

Туре	Location	Notes

Additional design sources

Prebuilt

File	File-Extension	Description
BIT-File	*.bit	FPGA (PL Part) Configuration File
DebugProbes-File	*.ltx	Definition File for Vivado/Vivado Labtools Debugging Interface
Debian SD-Image	*.img	Debian Image for SD-Card
Diverse Reports		Report files in different formats
Hardware-Platform- Specification-Files	*.xsa	Exported Vivado Hardware Specification for Vitis and PetaLinux
LabTools Project-File	*.lpr	Vivado Labtools Project File
MCS-File	*.mcs	Flash Configuration File with Boot-Image (MicroBlaze or FPGA part only)
MMI-File	*.mmi	File with BRAM-Location to generate MCS or BIT-File with *. elf content (MicroBlaze only)
Software-Application-File	*.elf	Software Application for Zynq or MicroBlaze Processor Systems

Prebuilt files (only on ZIP with prebuilt content)

Download

Reference Design is only usable with the specified Vivado/Vitis/PetaLinux version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

TE0725 "Test Board" Reference Design

Design Flow

⚠

Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first lunch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also:

- AMD Development Tools#XilinxSoftware-BasicUserGuides
- Vivado Projects TE Reference Design
- Project Delivery.

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "_create_win_setup.cmd" on Windows OS and "_create_linux_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also executed by Xilinx Vivado/Vitis GUI. For currently Scripts limitations on Win and Linux OS see: Proje ct Delivery Currently limitations of functionality

⚠

Caution! Win OS has a 260 character limit for path lengths which can affect the Vivado tools. To avoid this issue, use Virtual Drive or the shortest possible names and directory locations for the reference design (for example "x:\<project folder>")

1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell:

_create_win_setup.cmd/_create_linux_setup.sh -----Set design paths------- Run Design with: _create_win_setup -- Use Design Path: <absolute project path> _____ -----------TE Reference Design-----_____ -- (0) Module selection guide, project creation...prebuilt export... -- (1) Create minimum setup of CMD-Files and exit Batch -- (2) Create maximum setup of CMD-Files and exit Batch -- (3) (internal only) Dev -- (4) (internal only) Prod -- (c) Go to CMD-File Generation (Manual setup) -- (d) Go to Documentation (Web Documentation) -- (g) Install Board Files from Xilinx Board Store (beta) -- (a) Start design with unsupported Vivado Version (beta) -- (x) Exit Batch (nothing is done!) Select (ex.:'0' for module selection guide):

2. Press 0 and enter to start "Module Selection Guide"

- Create project and follow instructions of the product selection guide, settings file will be configured automatically during this process.
 - optional for manual changes: Select correct device and Xilinx install path on "design_basic_settings.cmd" and create Vivado project with "vivado_create_project_guimode.cmd"



Note: Select correct one, see also Vivado Board Part Flow

a. Create hardware description file (.xsa file) for PetaLinux project and export to prebuilt folder

run on Vivado TCL (Script generates design and export files into

"<project folder>\prebuilt\hardware\<short name>")

TE::hw_build_design -export_prebuilt

(i) Using Vivado GUI is the same, except file export to prebuilt folder.

4. Generate Programming Files with Vitis

run on Vivado TCL (Script generates applications and bootable files, which are defined in "test_board\sw_lib\apps_list.csv") TE::sw_run_vitis -all TE::sw_run_vitis (optional; Start Vitis from Vivado GUI or start with TE Scripts on Vivado TCL)

Note: Scripts generate applications and bootable files, which are defined in "sw_lib\apps_list.csv"

App from Firmware folder will be add into BlockRAM. If you add other app, you must select *.elf

manually on Vivado

TCL scripts generate also platform project, this must be done manually in case GUI is used. See Vitis

5. (optional) Copy Application (hello_te0725.elf) from prebuilt-folder into \firmware\microblaze_0\ and regenerate design with

run on Vivado TCL (Script generates design and export files into "<project
folder>\prebuilt\hardware\<short name>")
TE::hw_build_design -export_prebuilt

Launch

Programming

Check Module and Carrier TRMs for proper HW configuration before you try any design.

Reference Design is also available with prebuilt files. It's recommended to use TE prebuilt files for first launch.

Xilinx documentation for programming and debugging: Vivado/SDK/SDSoC-Xilinx Software Programming and Debugging

Get prebuilt boot binaries

- 1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell
- 2. Press 0 and enter to start "Module Selection Guide"
 - a. Select assembly version
 - b. Validate selection
 - c. Select create and open delivery binary folder



Note: Folder "<project folder>_binaries_<Article Name>" with subfolder "boot_<app name>" for different applications will be generated

QSPI

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- 1. Connect JTAG and power on carrier with module
- Open Vivado Project with "vivado_open_existing_project_guimode.cmd" or if not created, create with "vivado_create_project_guimode.cmd"

run on Vivado TCL (Script programs .mcs-File on QSPI flash)

TE::pr_program_flash -swapp hello_te0725

3. Press the reset button to start the application and see the output in the console

SD

Not used on this Example.

JTAG

- 1. Connect JTAG and power on PCB
- 2. Open Vivado HW Manager
- 3. Program FPGA with Bitfile from "prebuilt/hardware/<short dir>/"

Usage

- 1. Prepare HW like described on section Programming
- 2. Connect UART USB (most cases same as JTAG)
- 3. 1. FPGA Loads Bitfile from Flash

3. Hello Trenz will be run on UART console.

info: Do not reboot, if Bitfile programming over JTAG is used as programming method.

a. UART

Open Serial Console (e.g. putty) Hello TE0725 will run on endless loop.

- i. Speed: 9600 ii. COM Port: Win OS, see device manager, Linux OS see dmesg |grep tty (UART is *USB1)

🛃 со)M18 - PuT	TY	
Hello	TE0725	(Loop:	10)
Hello	TE0725	(Loop:	11)
Hello	TE0725	(Loop:	12)
Hello	TE0725	(Loop:	13)
Hello	TE0725	(Loop:	14)
Hello	TE0725	(Loop:	15)
U-11-	TROTOR	/T	1.61

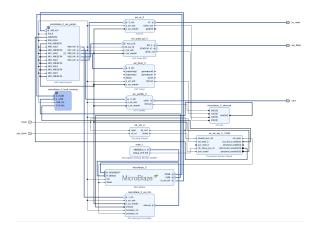
Power On PCB (Do not restart, if you use Bitfile programming)

Vivado HW Manager

• VIO Core for signal control and monitoring is not implemented

System Design - Vivado

Block Design



Constraints

Basic module constraints

_i_bitgen_common.xdc

```
set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]
set_property BITSTREAM.CONFIG.CONFIGRATE 66 [current_design]
set_property CONFIG_VOLTAGE 3.3 [current_design]
set_property CFGBVS VCCO [current_design]
set_property BITSTREAM.CONFIG.SPI_32BIT_ADDR YES [current_design]
set_property BITSTREAM.CONFIG.SPI_BUSWIDTH 4 [current_design]
set_property BITSTREAM.CONFIG.M1PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M0PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M0PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M0PIN PULLNONE [current_design]
```

Design specific constraints

Software Design - Vitis

For SDK project creation, follow instructions from:

Vitis

Application

Template location: "<project folder>\sw_lib\sw_apps\"

hello_te0725

Trenz Hello TE0725 example as endless loop. Output on console.

Template location: \sw_lib\sw_apps\hello_te0725

The printed Text can be modified.

Additional Software

No additional software is needed.

Appx. A: Change History and Legal Notices

Document Change History

To get content of older revision got to "Change History" of this page and select older document revision number.

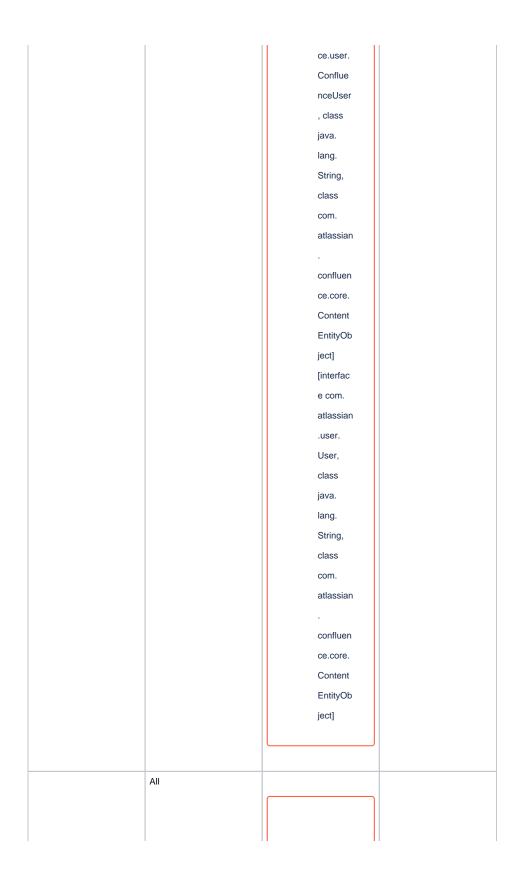
Date Document Revision Authors Description	ate	Document Revision	Authors	Description	
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	I	
 		2021.2 update Documentation style
Error	Error	update Error
renderi	renderi	renderi
ng	ng	ng
macro	macro	macro
'page-	'page-	'page-
info'	info'	info'
Ambiguo	Ambiguo	Ambiguo
us	us	us
method	method	method
overload	overload	overload
ing for	ing for	ing for
method	method	method
jdk.	jdk.	jdk.
proxy24	proxy24	proxy24
1.\$Proxy	1.\$Proxy	1.\$Proxy
3496#ha	3496#ha	3496#ha
sConten	sConten	sConten
tLevelPe	tLevelPe	tLevelPe
rmission	rmission	rmission
Cannot	Cannot	Cannot
resolve	resolve	resolve
which	which	which
method	method	method
to	to	to
invoke	invoke	invoke
for [null,	for [null,	for [null,
class	class	class
java.	java.	java.
lang.	lang.	lang.
String,	String,	String,
class	class	class
com.	com.	com.
atlassian	atlassian	atlassian
confluen	confluen	confluen
ce.	ce.	ce.

pages.	pages.	pages.
Page]	Page]	Page]
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overlapp	overlapp	overlapp
ing	ing	ing
prototyp	prototyp	prototyp
es	es	es
between	between	between
:	:	:
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atlassian	atlassian	atlassian
confluen	confluen	confluen
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Conflue	Conflue	Conflue
nceUser	nceUser	nceUser
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lang.	lang.	lang.
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class	class	class
com.	com.	com.
atlassian	atlassian	atlassian
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atlassian	atlassian	atlassian
.user.	.user.	.user.
User,	User,	User,
class	class	class
java.	java.	java.
lang.	lang.	lang.
String,	String,	String,

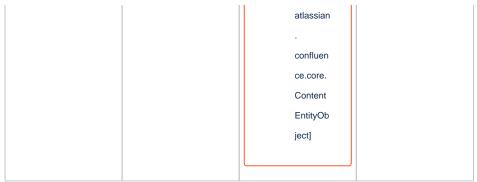
class	class	class	
com.	com.	com.	
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2020-04-27		John Hartfiel	
	v.13		• typo
2020-04-20	v.12	John Hartfiel	
			2019.2 updateDocumentation style
			update
2018-08-09	v.9	John Hartfiel	
			 2018.2 update
2018.06.05	v.8	John Hartfiel	
			 Board Part Documentation
			update Typo correction
			UART Speed
2018-03-16	v.5	John Hartfiel	
	1.0		• 2017.4 release
2018-03-12	v.1		
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jdk. proxy24 1.\$Proxy 3496#ha sConten tLevelPe rmission Cannot resolve which method to invoke for [null, class java. lang. String, class com. atlassian confluen ce. pages. Page] due to overlapp ing prototyp es between [interfac e com. atlassian confluen



Error renderi ng macro 'pageinfo' Ambiguo us method overload ing for method jdk. proxy24 1.\$Proxy 3496#ha sConten tLevelPe rmission Cannot resolve which method to invoke for [null, class java. lang. String, class com. atlassian confluen ce. pages. Page]

due to overlapp ing prototyp es between [interfac e com. atlassian confluen ce.user. Conflue nceUser , class java. lang. String, class com. atlassian confluen ce.core. Content EntityOb ject] [interfac e com. atlassian .user. User, class java. lang. String, class com.



Document change history.

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Error rendering macro 'page-info'

Ambiguous method overloading for method jdk.

proxy241.\$Proxy3496#hasContentLevelPermission. Cannot resolve which method to

invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due

to overlapping prototypes between: [interface com.atlassian.confluence.user.

ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.

ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class

com.atlassian.confluence.core.ContentEntityObject]